

Electronic Acknowledgement Receipt

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| EFS ID: | 1124417 |
| Application Number: | 10816559 |
| Confirmation Number: | 1225 |
| Title of Invention: | Low-K interlayer dielectric wafer grinding |
| First Named Inventor: | Yew Wee Cheong |
| Customer Number: | 31817 |
| Filer: | Angela Moore Sagalewicz/Heather Adamson |
| Filer Authorized By: | Angela Moore Sagalewicz |
| Attorney Docket Number: | 111079-136359 |
| Receipt Date: | 24-JUL-2006 |
| Filing Date: | 30-MAR-2004 |
| Time Stamp: | 19:06:16 |
| Application Type: | Utility |
| International Application Number: | |

Payment information:

| | |
|--|--------|
| Submitted with Payment | yes |
| Payment was successfully received in RAM | \$ 790 |
| RAM confirmation Number | 566 |
| Deposit Account | 500393 |

File Listing:

| Document Number | Document Description | File Name | File Size(Bytes) | Multi Part | Pages |
|-----------------|----------------------|-----------|------------------|------------|-------|
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|---|--|--|--------------|------------|----|
| 1 | | Intel_P18799_RCE_Respon se_07_24_06.pdf | 98395 | yes | 10 |
| | Multipart Description | | | | |
| | Doc Desc | | Start | End | |
| | Amendment Submitted/Entered with Filing of CPA/RCE | | 1 | 1 | |
| | Claims | | 2 | 6 | |
| | Applicant Arguments/Remarks Made in an Amendment | | 7 | 10 | |
| Warnings: | | | | | |
| Information: | | | | | |
| 2 | Request for Continued Examination (RCE) | Intel_P18799_RCE_07_24_ 06.pdf | 181886 | no | 1 |
| Warnings: | | | | | |
| Information: | | | | | |
| 3 | Fee Worksheet (PTO-875) | fee-info.pdf | 8164 | no | 2 |
| Warnings: | | | | | |
| Information: | | | | | |
| Total Files Size (in bytes): | | | 288445 | | |
| <p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> | | | | | |